

ATTENTION **OBSERVE PRECAUTIONS** FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- 1.0mmX0.5mm SMD LED, 0.5mm thickness.
- Low power consumption.
- · Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- · RoHS compliant.

1.0X0.5mm SMD CHIP LED LAMP

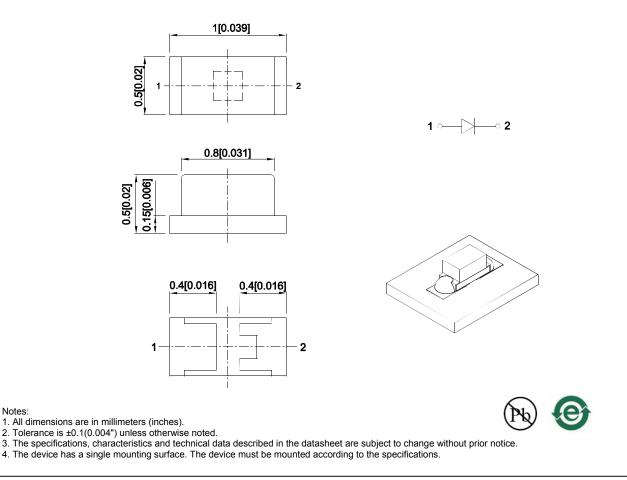
Part Number: APHHS1005ZGCK

Green

Descriptions

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



SPEC NO: DSAM6355 **APPROVED: Wynec**

Notes:

REV NO: V.4B CHECKED: Allen Liu

DATE: JUL/01/2016 DRAWN: W.Q.Zhong PAGE: 1 OF 5 ERP: 1203013391

Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [@ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APHHS1005ZGCK	Green (InGaN)	Water Clear	200	400	140°

Notes:

01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity / luminous Flux: +/-15%.
Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Green	525		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
IR	Reverse Current	Green		50	uA	VR=5V

Notes: 1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V. 3. Wavelength value is traceable to CIE127-2007 standards.

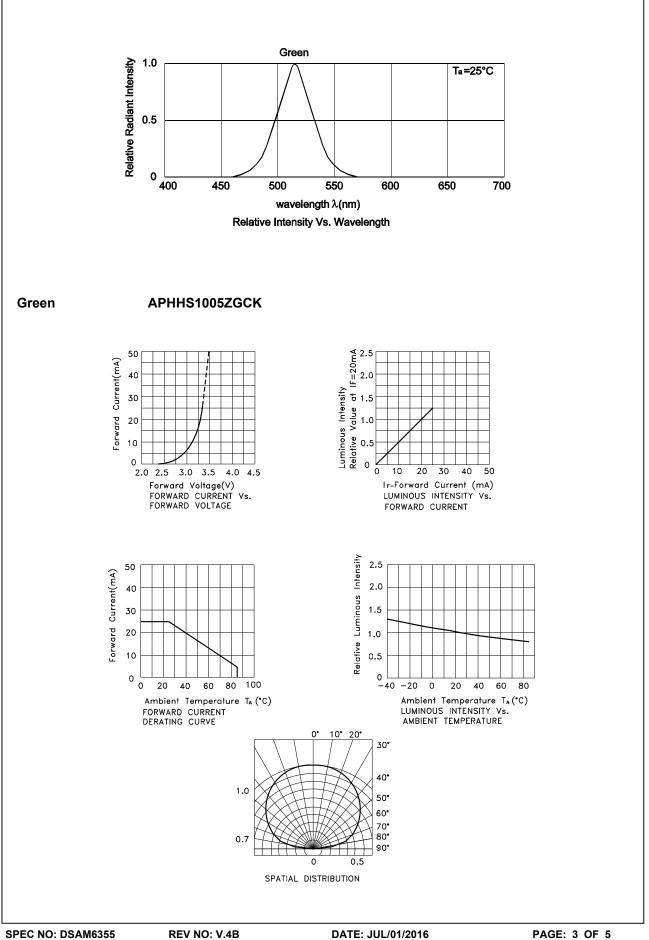
Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Electrostatic Discharge Threshold (HBM)	450	V	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

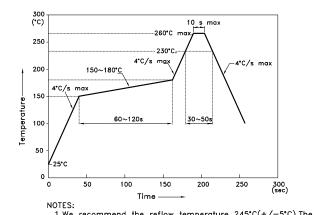
Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



APHHS1005ZGCK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

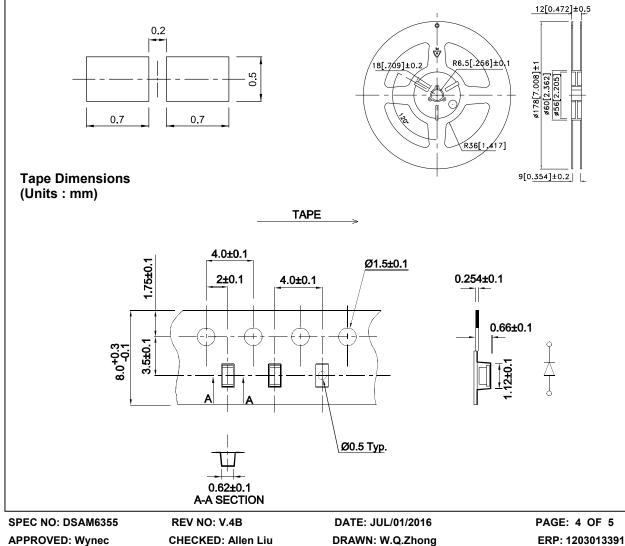
Reflow Soldering Profile For Lead-free SMT Process.

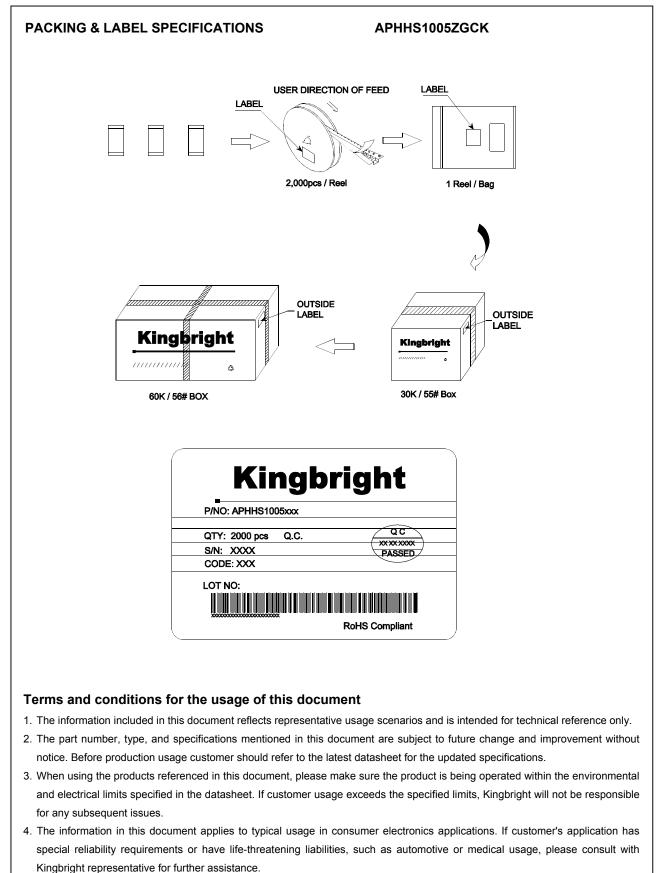


NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



Reel Dimension





- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

DATE: JUL/01/2016 DRAWN: W.Q.Zhong